TRANSMITTAL FORM

		PTO/SB/21 (08-00)				
	Application Number	09/535,015				
	Filing Date	March 24, 2000				
	First Named Inventor	Shunpei YAMAZAKI et al.				
	Group Art Unit	2811				
	Examiner Name	S. Crane				
	Attorney Docket Number	0756-2131				

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Total Number of Pages in This	Submission		Attorney Docket Numb	er	0756-2131					
ENCLOSURES (check all that apply)										
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Date	August 3, 2	2006								
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Type or printed name	Adel	e M. Stam	per							
Signature	aa	lile M	Stanper		August 3, 2006					

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Attorney Docket No. 0756-2131

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Pre Patent Application of:)	Group Art Unit: 2811
Shunpei YAMAZAKI et al.)	Examiner: S. Crane
Serial No. 09/535,015)	CERTIFICATE OF MAILING I hereby certify that this correspondence is
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INFORMATION DISCLOSURE STATEMENT AND CORRECTION OF PREVIOUSLY SUBMITTED INFORMATION DISCLOSURE STATEMENT

Honorable Commissioner of Patents P.O. Box 1450 Alexandria, VA 22313-1450

Dear Sir:

It has come to applicant's attention that several Information Disclosure Statements previously submitted included inadvertent typographical incomplete information.

Specifically, the Information Disclosure Statement filed December 19, 2000 included the following inaccuracies:

- EP 0 178 447 was incorrectly listed with a publication date of 09/10/1984. The correct publication date is 04/23/1986; and
- Several articles did not include an appropriate title, page number, spelling of the author's name, or publication.

The Information Disclosure Statements filed September 5, 2001 and March 17, 2003 included articles which did not include a publication date and page number.

The above inaccuracies are corrected on the 1449 Form attached hereto. The Examiner is requested to initial the attached PTO Form 1449 evidencing consideration of the above references and line through these references on the previously submitted

Information Disclosure Statements to ensure that the correct information is printed correctly on any issued patent.

Respectfully submitted,

Eric J. Robinson

Reg. No. 38,285

Robinson Intellectual Property Law Office, P.C. PMB 955 21010 Southbank Street Potomac Falls, Virginia 20165 (571) 434-6789

Approved for use through 10/31/2002. OMB 0651-0031

U.S. Patent and Trademark Office: U.S. DEPARTMENT OF COMMERCE
Under the Paperwork Reduction Act of 1995, no persons are required to respond to a collection of information unless it contains a valid OMB control number. Complete if Known Substitute for form 1449A/PTO EINFORMATION DISCLOSURE 09/535,015 **Application Number** March 24, 2000 Filing Date **EMENT BY APPLICANT** Shunpei YAMAZAKI et al. First Named Inventor (use as many sheets as necessary) **Group Art Unit** 2811 Sara W. Crane **Examiner Name**

Sheet	1/1			of	2		Attorney Docket Number		0756-2131		
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Examiner Initials	Cite No.1 Foreign Patent Document Kind Code ³ Office ³ Number ⁴ (if known)		Name of Patentee or Applicant of Cited Document	Date of Publication of Cited Document MM-DD-YYYY		Pages, Columns, Lines, Where Relevant Passages or Relevant Figures Appear	Ţ ⁶				
		EP	EP 0 178 447					04/23/1986		Eng.	
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Signature		Considered	

^{*}EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609. Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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Examiner	Date.	
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